

DEC 28 2006

PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277  
 :  
 Shuji HIRAO : Confirmation Number: 6629  
 :  
 Application No.: 10/624,564 : Group Art Unit: 1753  
 :  
 Filed: July 23, 2003 : Examiner: WONG, Edna  
 :

For: METHOD AND APPARATUS FOR PLATING SUBSTRATE

Mail Stop Amendment  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ No additional fee is required.  
☐ Applicant is entitled to small entity status under 37 CFR 1.27  
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	16	30	0	\$50.00 =	\$0.00
Independent Claims	2	4	0	\$200.00 =	\$0.00
Multiple dependent claims newly presented					\$0.00
Fee for extension of time					\$0.00
					\$0.00
Total of Above Calculations					\$0.00

- ☐ Please charge my Deposit Account No. 500417 in the amount of \$0.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

McDERMOTT WILL &amp; EMERY LLP

Michael E. Fogarty  
 Registration No. 36,139

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 Date: December 28, 2006

Please recognize our Customer No. 20277 as our  
 correspondence address.



Docket No.: 060188-0594

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**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated September 28, 2006, having a three-month shortened statutory period for response set to expire December 28, 2006, please amend the above-identified application as follows.